

# 1.0A, 600V N-CHANNEL POWER MOSFET

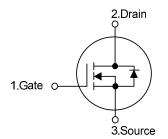
### DESCRIPTION

The UTC **F1N60Q-TA** is a high voltage power MOSFET combines advanced planar MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

### FEATURES

- \*  $R_{DS(ON)} \le 8.2 \ \Omega \ @ V_{GS} = 10V, \ I_D = 1.5A$
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

#### SYMBOL



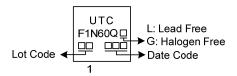
### ORDERING INFORMATION

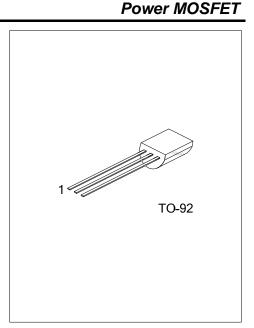
Ordering Number		Deekere	Pin Assignment			Deaking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
F1N60QL-T92-B	F1N60QG-T92-B	TO-92	G	D	S	Tape Box	
F1N60QL-T92-K	F1N60QG-T92-K	TO-92	G	D	S	Bulk	
Nata Dia Assissante O. C							

Note: Pin Assignment: G: Gate D: Drain S: Source

F1N60QG- <u>T92</u> -B	
(1)Packing Type	(1) B: Tape Box, K: Bulk
(2)Package Type	(2) T92: TO-92
(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free

#### MARKING





### ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub>=25°C, unless otherwise specified)

T					
PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V <sub>DSS</sub>	600	V	
Gate-Source Voltage		V <sub>GSS</sub>	±30	V	
Continuous Drain Current		I <sub>D</sub>	1	А	
Pulsed Drain Current (Note 2)		I <sub>DM</sub>	2	А	
Avalanche Energy Single	e Pulsed (Note 3)	E <sub>AS</sub>	34	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.8	V/ns	
Power Dissipation		PD	2	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 30mH,  $I_{AS}$  = 1.5A,  $V_{DD}$  = 50V,  $R_G$  = 25  $\Omega$ , Starting  $T_J$  = 25°C

4.  $I_{SD} \le 1.0A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ 

#### THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	$\theta_{JA}$	160	°C/W
Junction to Case	$\theta_{Jc}$	92.5 (Note)	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

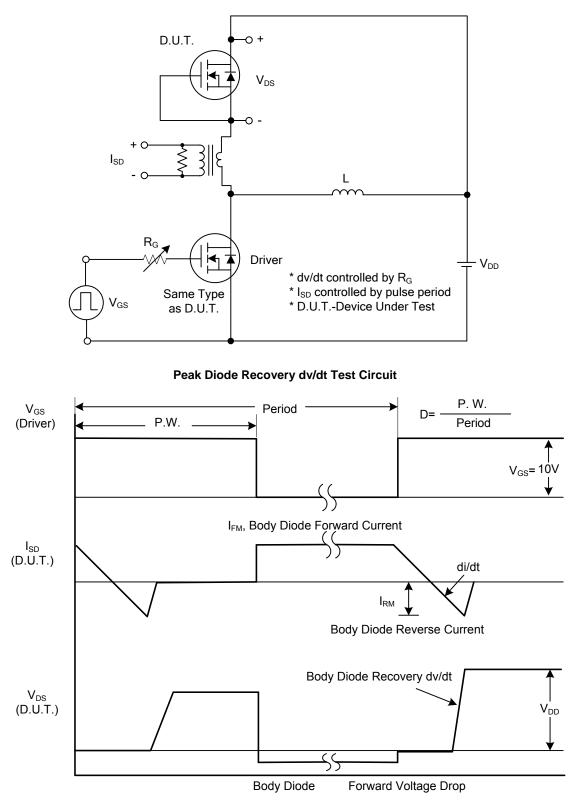
#### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

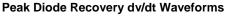
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS					1		
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA	600			V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V			10	μA
Cata Sauraa Laakana Currant	Forward		V <sub>GS</sub> =30V, V <sub>DS</sub> =0V			100	nA
Gate- Source Leakage Current	Reverse	I <sub>GSS</sub>	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			10	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	2.0		4.0	V
Static Drain-Source On-State Res	istance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =0.5A			8.2	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		CISS			160		pF
Output Capacitance		C <sub>OSS</sub>	$\begin{array}{c c c c c c c c c c c c c c c c c c c $		рF		
Reverse Transfer Capacitance		C <sub>RSS</sub>			2.1		рF
SWITCHING CHARACTERISTIC	S						
Total Gate Charge (Note 1)		$Q_{G}$			8.6		nC
Gate-Source Charge		Q <sub>GS</sub>	$V_{DS}$ =480V, $V_{GS}$ =10V, $I_D$ =1.0A		3.1		nC
Gate-Drain Charge		Q <sub>GD</sub>		600   2.0   2.0   2.0   2.1   2.1   2.1   2.1   3.1   1.2   3   16   16		nC	
Turn-On Delay Time (Note 1)		t <sub>D(ON)</sub>			3		ns
Turn-On Rise Time	urn-On Rise Time		V <sub>DS</sub> =100V, V <sub>GS</sub> =10V,		16		ns
Turn-Off Delay Time		t <sub>D(OFF)</sub>	$I_D$ =1.0A, $R_G$ =25 $\Omega$ (Note 1, 2)		16		ns
Turn-Off Fall Time		t <sub>F</sub>		160     21     2.1     3.1     1.2     3     16		ns	
DRAIN-SOURCE DIODE CHARA	CTERISTICS	AND MAXI	MUM RATINGS			-	
Maximum Body-Diode Continuous	Current	ls				1	Α
Maximum Body-Diode Pulsed Cur	rent	I <sub>SM</sub>				2	Α
Drain-Source Diode Forward Volta	age (Note 1)	V <sub>SD</sub>	I <sub>S</sub> =1.0A , V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =1.0A , V <sub>GS</sub> =0V		74		ns
Reverse Recovery Charge		Qrr	di/dt=100A/µs		90		nC
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Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle  $\leq$  2%.

2. Essentially independent of operating temperature.

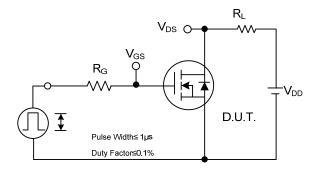
# TEST CIRCUITS AND WAVEFORMS



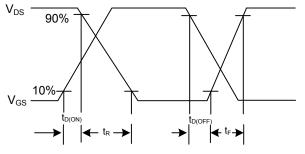




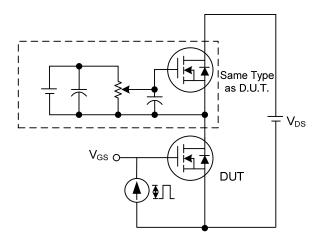
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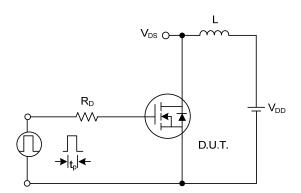




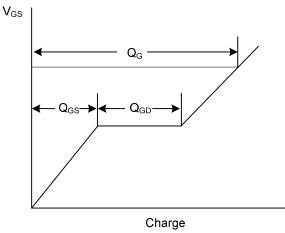
Switching Waveforms



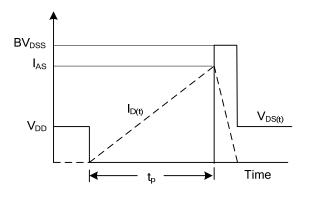
Gate Charge Test Circuit



**Unclamped Inductive Switching Test Circuit** 





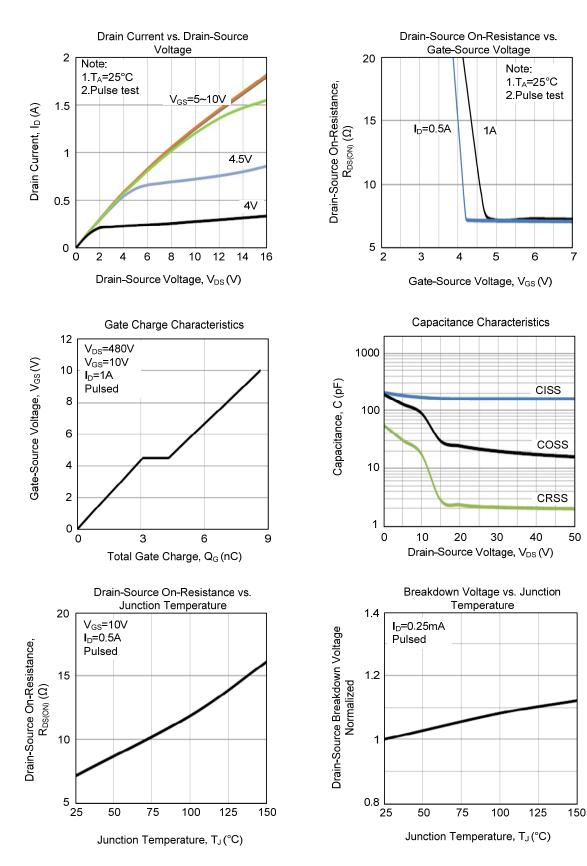






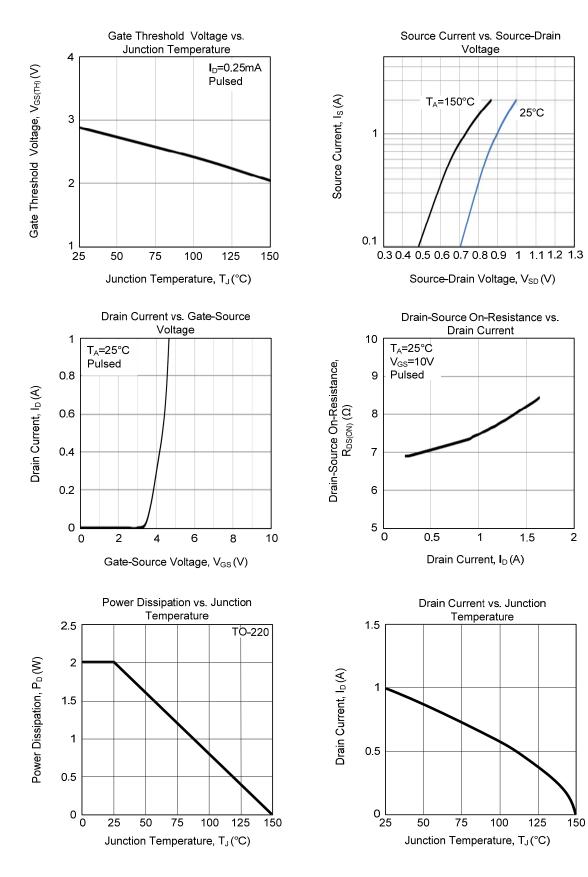
# **Power MOSFET**

### TYPICAL CHARACTERISTICS



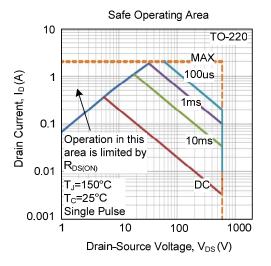


### ■ TYPICAL CHARACTERISTICS (Cont.)





# TYPICAL CHARACTERISTICS (Cont.)



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